8-bit bus switch with output enable Rev. 1 — 30 December 2010

Product data sheet

1. **General description**

The 74CBTLV3245 is an 8-pole, single-throw bus switch. The device features a single output enable input (\overline{OE}) that controls eight switch channels. The switches are disabled when OE is HIGH. Schmitt-trigger action at control inputs makes the circuit tolerant of slower input rise and fall times. This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. **Features and benefits**

- Supply voltage range from 2.3 V to 3.6 V
- High noise immunity
- Complies with JEDEC standard:
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8-B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
- 5 Ω switch connection between two ports
- Rail to rail switching on data I/O ports
- CMOS low power consumption
- Latch-up performance exceeds 250 mA per JESD78B Class I level A
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



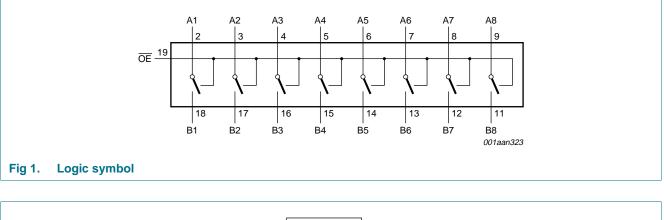
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3. Ordering information

Type number	Package						
	Temperature range	Name	Description	Version			
74CBTLV3245DS	–40 °C to +125 °C	SSOP20[1]	plastic shrink small outline package; 20 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT724-1			
74CBTLV3245PW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1			
74CBTLV3245BQ	–40 °C to +125 °C	DHVQFN20	plastic dual-in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	SOT764-1			

[1] Also known as QSOP20 package

4. Functional diagram



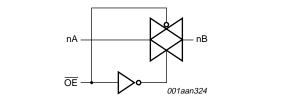
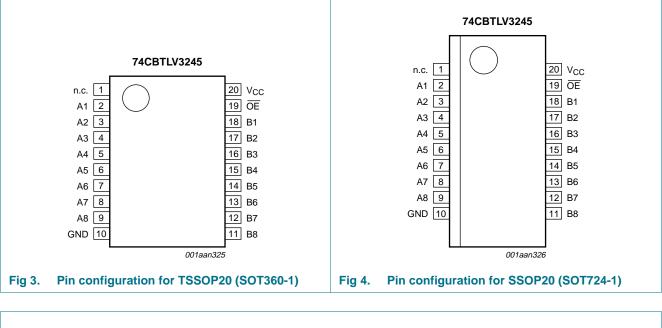


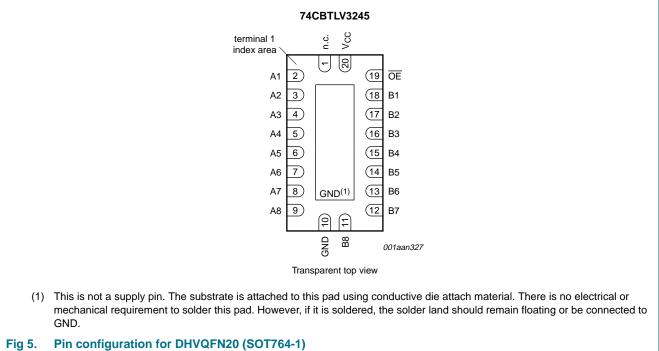
Fig 2. Logic diagram (one switch)

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5. Pinning information

5.1 Pinning





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5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
nc	1	not connected
A1 to A8	2, 3, 4, 5, 6, 7, 8, 9	data input/output (A port)
GND	10	ground (0 V)
B1 to B8	18, 17, 16, 15, 14, 13, 12, 1	1 data input/output (B port)
OE	19	output enable input (active LOW)
V _{CC}	20	positive supply voltage

6. Functional description

Table 3. Function selection^[1]

Input OE	Input/output
OE	An, Bn
L	An = Bn
Н	Z

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
V _{SW}	switch voltage	enable and disable mode	<u>[1]</u> –0.5	V _{CC} + 0.5	V
l _{IK}	input clamping current	V _I < -0.5 V	-50	-	mA
I _{SK}	switch clamping current	$V_{I} < -0.5 V$	-50	-	mA
I _{SW}	switch current	$V_{SW} = 0 V \text{ to } V_{CC}$	-	±128	mA
I _{CC}	supply current		-	+100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[2] _	500	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SSOP20 and TSSOP20 packages: above 60 °C the value of P_{tot} derates linearly at 5.5 mW/K. For DHVQFN20 packages: above 60 °C the value of P_{tot} derates linearly at 4.5 mW/K.

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8. Recommended operating conditions

V_{CC} supply voltage2.33.6V V_1 input voltage03.6V V_{SW} switch voltageenable and disable mode0 V_{CC} V T_{amb} ambient temperature-40+1250	Table 5.	Recommended operating conditi	ons			
V_I input voltage03.6V V_{SW} switch voltageenable and disable mode0 V_{CC} V T_{amb} ambient temperature-40+125 V_{CC}	Symbol	Parameter	Conditions	Min	Max	Unit
V_{SW} switch voltageenable and disable mode0 V_{CC} V T_{amb} ambient temperature-40+1250	V _{CC}	supply voltage		2.3	3.6	V
T _{amb} ambient temperature -40 +125	VI	input voltage		0	3.6	V
	V _{SW}	switch voltage	enable and disable mode	0	V _{CC}	V
$\Delta t / \Delta V$ input transition rise and fall rate $V_{CC} = 2.3 V$ to 3.6 V [1] - 200 r	T _{amb}	ambient temperature		-40	+125	°C
	$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 2.3 V to 3.6 V	<u>[1]</u> _	200	ns/V

[1] Applies to control signal levels.

9. Static characteristics

Table 6.Static characteristics

At recommended operating conditions voltages are referenced to GND (ground = 0 V).

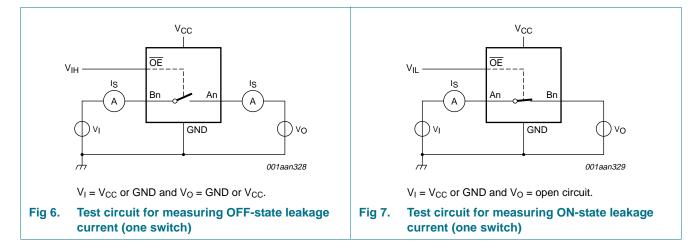
Symbol	Parameter	Conditions	T _{amb} =	–40 °C to	+85 °C	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$		Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	1
V _{IH}	HIGH-level	V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
	input voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V _{IL}		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
	voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.9	-	0.9	V
I	input leakage current	pin \overline{OE} ; V _I = GND to V _{CC} ; V _{CC} = 3.6 V	-	-	±1	-	±20	μA
I _{S(OFF)}	OFF-state leakage current	V_{CC} = 3.6 V; see <u>Figure 6</u>	-	-	±1	-	±20	μA
I _{S(ON)}	ON-state leakage current	V_{CC} = 3.6 V; see <u>Figure 7</u>	-	-	±1	-	±20	μA
I _{OFF}	power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V}$	-	-	±10	-	±50	μA
I _{CC}	supply current		-	-	10	-	50	μA
ΔI_{CC}	additional supply current	pin $\overline{\text{OE}}$; V _I = V _{CC} - 0.6 V; V _{SW} = GND or V _{CC} ; V _{CC} = 3.6 V	[2] _	-	300	-	2000	μA
CI	input capacitance	pin \overline{OE} ; V _{CC} = 3.3 V; V _I = 0 V to 3.3 V	-	0.9	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance	V_{CC} = 3.3 V; V_{I} = 0 V to 3.3 V	-	5.2	-	-	-	pF
$C_{S(ON)}$	ON-state capacitance	V_{CC} = 3.3 V; V_{I} = 0 V to 3.3 V	-	14.3	-	-	-	pF

[1] All typical values are measured at T_{amb} = 25 $^\circ C.$

[2] One input at 3 V, other inputs at V_{CC} or GND.

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9.1 Test circuits



9.2 ON resistance

Table 7. Resistance R_{ON}

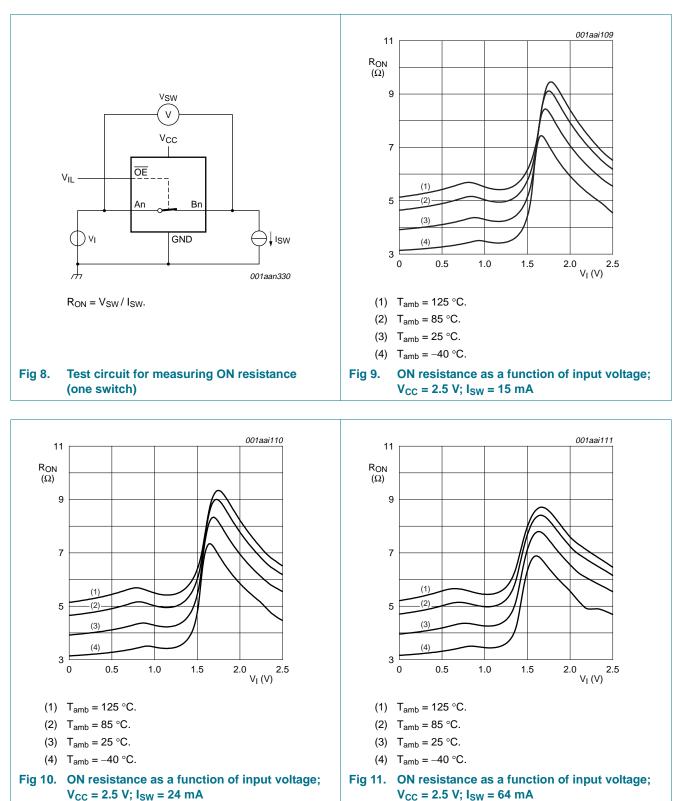
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

Symbol	Parameter	Conditions	T _{amb} =	–40 °C to	+85 °C	T_{amb} = -40 °	C to +125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
R _{ON} ON resistance	$V_{CC} = 2.3 V \text{ to } 2.7 V;$ see <u>Figure 9</u> to <u>Figure 11</u>	2]					·	
		$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	4.2	8.0	-	15.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	4.2	8.0	-	15.0	Ω
		$I_{SW} = 15 \text{ mA}; V_I = 1.7 \text{ V}$	-	8.4	40	-	60.0	Ω
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V};$ see <u>Figure 12</u> to <u>Figure 14</u>						
		$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	4.0	7.0	-	11.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	4.0	7.0	-	11.0	Ω
		I_{SW} = 15 mA; V_{I} = 2.4 V	-	6.2	15	-	25.5	Ω

[1] Typical values are measured at T_{amb} = 25 °C and nominal V_{CC}.

[2] Measured by the voltage drop between the A and B terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

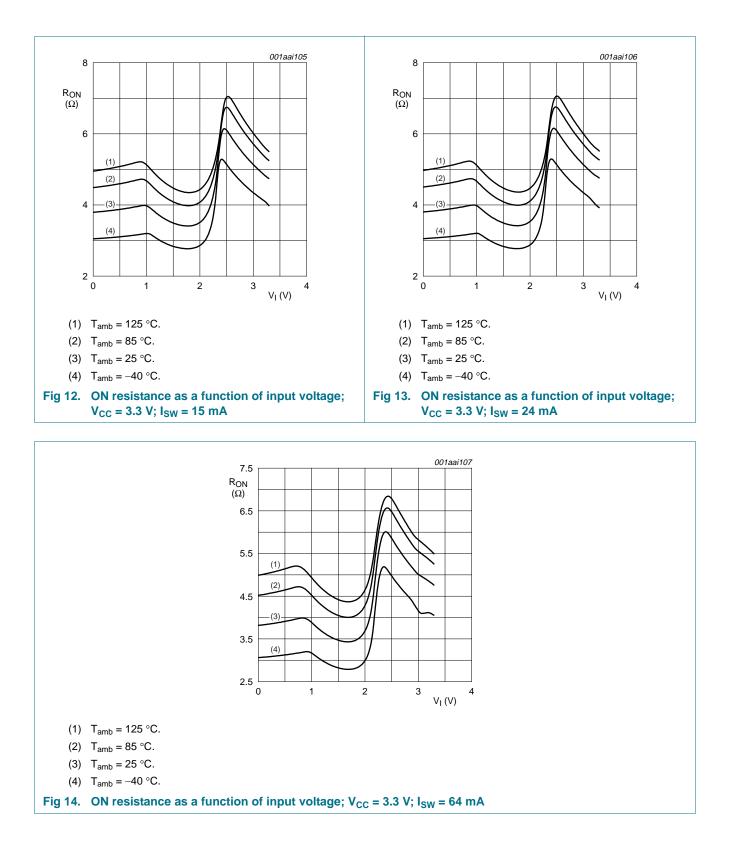
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9.3 ON resistance test circuit and graphs

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10. Dynamic characteristics

Table 8. Dynamic characteristics

GND = 0 V; for test circuit see Figure 17

Symbol	Parameter	Conditions		T _{amb} = -	–40 °C to	+85 °C	T_{amb} = -40 °	C to +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	An to Bn or Bn to An; see <u>Figure 15</u>	[2][3]						
		V_{CC} = 2.3 V to 2.7 V		-	-	0.13	-	0.20	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	-	0.20	-	0.31	ns
t _{en} e	enable time	OE to An or Bn; see <u>Figure 16</u>	<u>[4]</u>						
		V_{CC} = 2.3 V to 2.7 V		1.0	3.4	5.5	1.0	8.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	3.0	4.9	1.0	7.0	ns
t _{dis}	disable time	OE to An or Bn; see <u>Figure 16</u>	<u>[5]</u>						
		V_{CC} = 2.3 V to 2.7 V		1.0	3.0	5.5	1.0	8.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	3.4	5.8	1.0	8.5	ns

[1] All typical values are measured at T_{amb} = 25 °C and at nominal V_{CC}.

[2] The propagation delay is the calculated RC time constant of the on-state resistance of the switch and the load capacitance, when driven by an ideal voltage source (zero output impedance).

 $[3] \quad t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}.$

[4] t_{en} is the same as t_{PZH} and t_{PZL} .

[5] t_{dis} is the same as t_{PHZ} and t_{PLZ} .

11. Waveforms

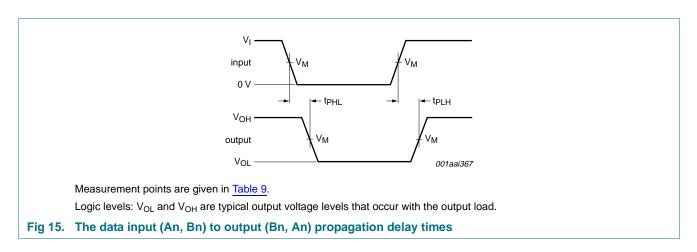


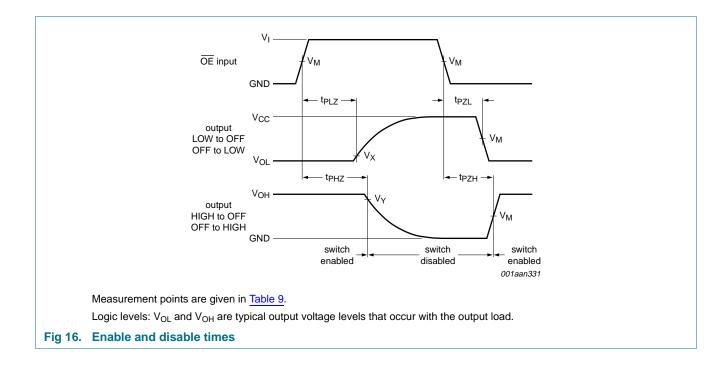
Table 9. Measurement points

Supply voltage	Input			Output	Output		
V _{CC}	V _M	VI	$t_r = t_f$	V _M	V _X	V _Y	
2.3 V to 2.7 V	$0.5V_{CC}$	V _{CC}	\leq 2.0 ns	$0.5V_{CC}$	V _{OL} + 0.15 V	$V_{OH} - 0.15 \ V$	
3.0 V to 3.6 V	$0.5V_{CC}$	V _{CC}	\leq 2.0 ns	$0.5V_{CC}$	V _{OL} + 0.3 V	$V_{OH} - 0.3 \ V$	

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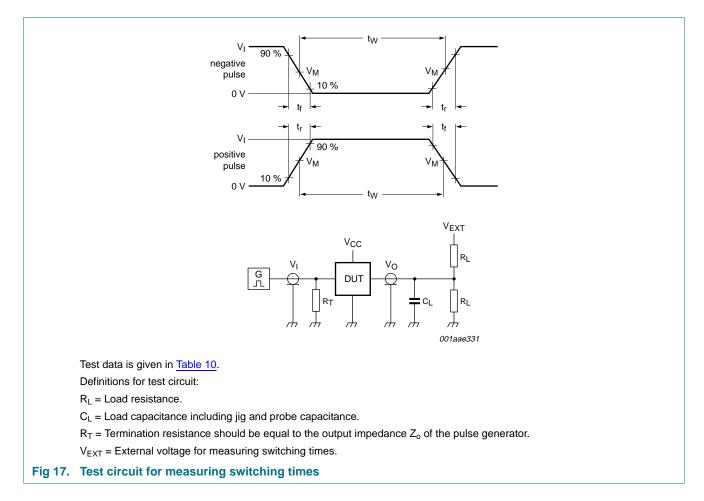


Table 10. Test data

Supply voltage	Load	V _{EXT}			
V _{cc}	CL	RL	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
2.3 V to 2.7 V	30 pF	500 Ω	open	GND	2V _{CC}
3.0 V to 3.6 V	50 pF	500 Ω	open	GND	2V _{CC}

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12. Package outline

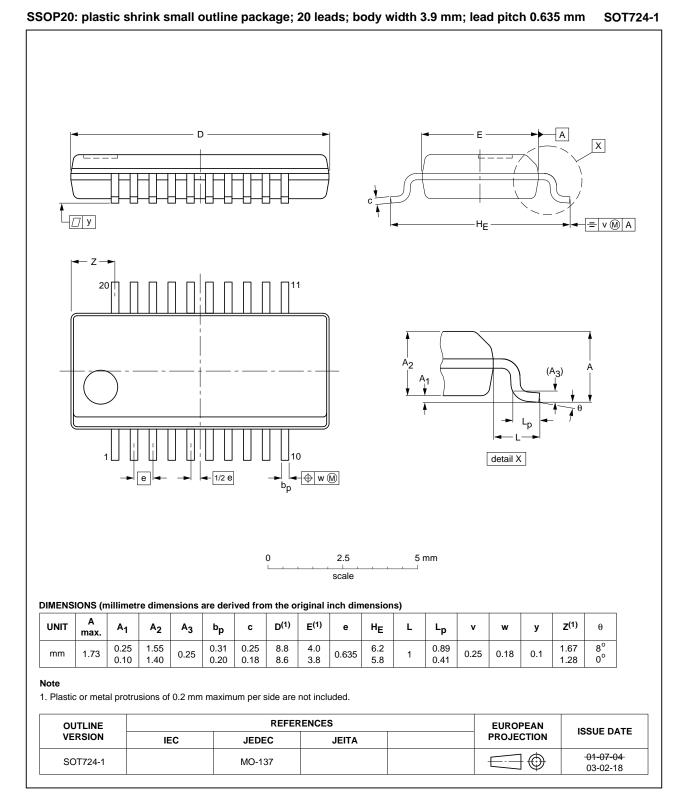


Fig 18. Package outline SOT724-1 (SSOP20)

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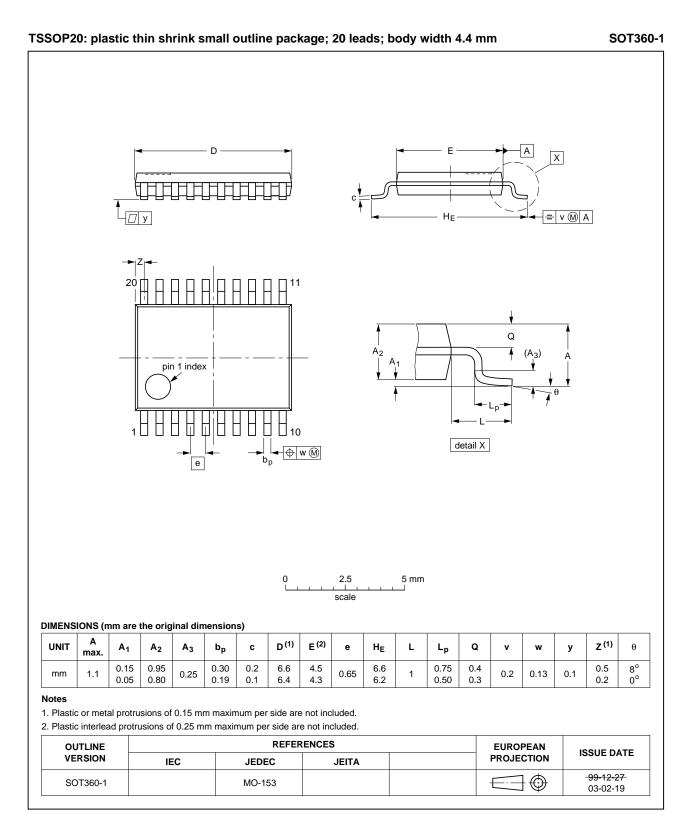
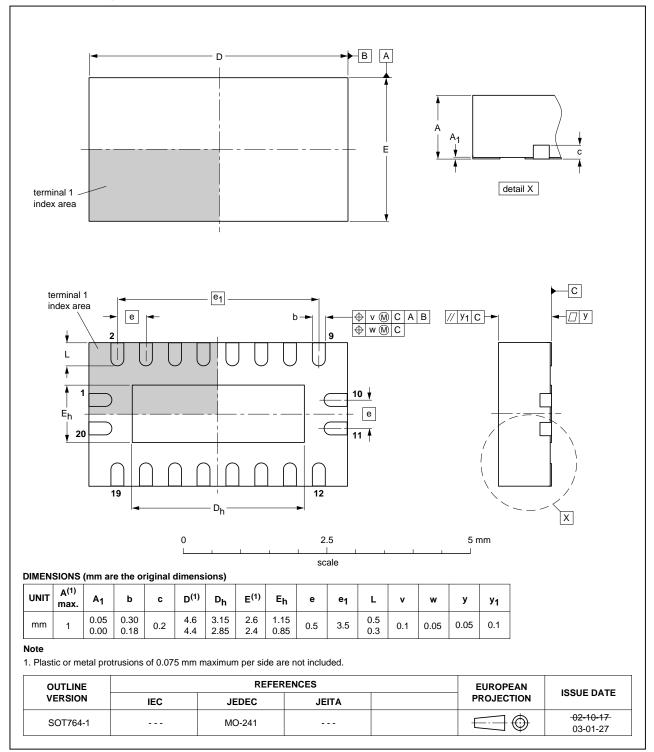


Fig 19. Package outline SOT360-1 (TSSOP20)

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 20. Package outline SOT764-1 (DHVQFN20)

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13. Abbreviations

Description
Charged Device Model
Complementary Metal-Oxide Semiconductor
Device Under Test
ElectroStatic Discharge
Human Body Model
Machine Model

14. Revision history

Table 12. Revision history								
Document ID	Release date	Data sheet status	Change notice	Supersedes				
74CBTLV3245 v.1	20101230	Product data sheet	-	-				

15. Legal information

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Document status[1][2]	Product status ^[3]	Definition
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Date of release: 30 December 2010 Document identifier: 74CBTLV3245